ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

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LG566303701

Report verification at igi.org

LABORATORY GROWN DIAMOND REPORT

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— 59.5% —

Long

LG566303701

EMERALD CUT

1.10 CARAT

VS 1

63.6%

EXCELLENT

EXCELLENT

LABGROWN (6) LG566303701

NONE

DIAMOND

LABORATORY GROWN

7.13 X 4.97 X 3.16 MM

January 31, 2023

IGI Report Number

Shape and Cutting Style

Description

Measurements

Carat Weight

Color Grade

Clarity Grade

Medium

Polish

Type II

Symmetry

Fluorescence

Inscription(s)

47%

ADDITIONAL GRADING INFORMATION

GRADING RESULTS

GRADING SCALES

CLARITY

IF	VVS ¹⁻²	VS ¹⁻²	SI 1-2	I 1 - 3
Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included

COLOR

D	Ε	F	G	Н	1	J	Faint	Very Light	Light

PROPORTIONS

LG566303701

DIAMOND **EMERALD CUT**

1.10 CARAT

EXCELLENT

EXCELLENT

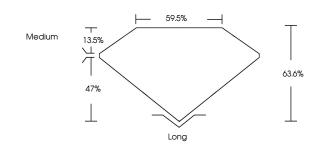
LABGROWN 1/5/1 LG566303701

NONE

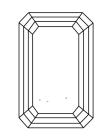
VS 1

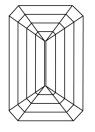
LABORATORY GROWN

7.13 X 4.97 X 3.16 MM



CLARITY CHARACTERISTICS





KEY TO SYMBOLS

Red symbols indicate internal characteristics. Green symbols indicate external characteristics.





LASERSCRIBESM Sample Image Used



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FD - 10 20





Comments: As Grown - No indication of post-growth

This Laboratory Grown Diamond was created by High

Pressure High Temperature (HPHT) growth process.



January 31, 2023

IGI Report Number

Description

Measurements

Shape and Cutting Style

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence Inscription(s)

Comments: As Grown - No indication of post-growth treatment.

This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

www.igi.org

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